



THC63LVDF84B(5S)

LVDS 24Bit COLOR HOST-LCD PANEL INTERFACE RECEIVER(Falling Edge Clock)

General Description

The THC63LVDF84B(5S) receiver convert the four LVDS(Low Voltage Differential Signaling) data streams back into 28bits of CMOS/TTL data with falling edge clock.

At a transmit clock frequency of 65MHz, 24bits of RGB data and 4bits of LCD timing and control data (HSYNC, VSYNC, CNTL1, CNTL2) are transmitted at a rate of 1.8Gbps.

Features

- Wide dot clock range: 20-65MHz suited for VGA, SVGA and XGA
- PLL requires No external components
- Low power consumption
- Power-Down Mode
- Low profile 56 Lead TSSOP Package
- Pin compatible with THC63LVDF84A

Block Diagram



(140-455Mbit/On Each LVDS Channel)



Pin Out



RC3 1 RC6 3 RD6 3 RC4 3 GND 4 RC5 5 RC6 6 RD0 7 LVDSGND 8 RA- 10 RA+ 10 RB- 11 RB+ 12 LVDSVCC 13 LVDSGND 145 RC- 16 RCLK- 17 RCLK+ 18 RD- 20 LVDSGND 212 PLLGND 22 PLLGND 22 PLLGND 24 /PDWN 25 CLKOUT 26 GND 28		56 55 55 55 55 55 55 55 55 55 55 55 55 5
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THC63LVDF84B(5S)

Pin Description

Pin Name	Pin #	Туре	Description	
RA+, RA-	10, 9	LVDS IN		
RB+, RB-	12, 11	LVDS IN		
RC+, RC-	16, 15	LVDS IN		
RD+, RD-	20, 19	LVDS IN		
RCLK+, RCLK-	18, 17	LVDS IN	LVDS Clock Inputs	
RA0~RA6	27,29,30,32,33,35,37	OUT		
RB0~RB6	38,39,43,45,46,47,51	OUT	Pixel Date Outpute	
RC0~RC6	53,54,55,1,3,5,6	OUT		
RD0~RD6	7,34,41,42,49,50,2	OUT		
CLKOUT	26	OUT	Pixel Clock Output	
	25	IN	H: Normal operation	
	20		L: Power down (all outputs are pulled to ground)	
VCC	31,40,48,56	Power	Power Supply Pins for TTL outputs and digital circuitry	
GND	4,28,36,44,52	Ground	Ground Pins for TTL outputs and digital circuitry	
LVDSVCC	13	Power	Power Supply Pin for LVDS inputs	
LVDSGND	8,14,21	Ground	Ground Pins for LVDS inputs	
PLLVCC	23	Power	Power Supply Pin for PLL circuitry	
PLLGND	22,24	Ground	Ground Pins for PLL circuitry	



Electrical Characteristics

CMOS/TTL DC SPECIFICATIONS

V_{CC} = VCC = PLL VCC = LVDS VCC

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Units
V _{IH}	High Level Input Voltage		2.0		V _{CC}	V
V _{IL}	Low Level Input Voltage		GND		0.8	V
V _{OH1}	High Level Output Voltage	I _{OH} = -4mA	2.4			V
V _{OL1}	Low Level Output Voltage	I _{OL} = 4mA			0.4	V
I _{IN}	Input Current	$0V \le VIN \le VCC$			±10	uA

LVDS RECEIVER DC SPECIFICATIONS

V_{CC} = VCC = PLL VCC = LVDS VCC

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Units
V _{TH}	Differential Input High Threshold			,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,	100	mV
V _{TL}	Differential Input Low Threshold	VOC = +1.2V	-100			mV
I _{IN}	Input Current	$V_{IN} = +2.4V/0V$			140	
		$V_{CC} = 3.6V$			±10	uA

Absolute Maximum Ratings¹

Supply Voltage (Vcc)	-0.3 to +4V
CMOS/TTL Input Voltage	-0.3 to (Vcc + 0.3V)
CMOS/TTL Output Voltage	-0.3V to (Vcc + 0.3V)
LVDS Receiver Input Voltage	-0.3V to (Vcc + 0.3V)
Junction Temperature	+125°C
Storage Temperature Range	-55°C to +150°C
Resistance to soldering heat	+260°C/10sec
Maximum Power Dissipation@25°C	0.5W

Recommended Operating Conditions

Parameter	Min	Тур	Max	Unit
All Supply Voltage	3.0	3.3	3.6	V
Operating Ambient Temperature	-40		85	°C
Differential CLKIN Frequency	20		65	MHz



^{1. &}quot;Absolute Maximum Ratings" are those valued beyond which the safety of the device can not be guaranteed. They are not meant to imply that the device should be operated at these limits. The tables of "Electrical Characteristics" specify conditions for device operation.





Supply Current

 $V_{CC} = VCC = PLL VCC = LVDS VCC$

Symbol	Parameter	Condition(*)	Тур.	Max.	Units
	Receiver Supply Current		11	50	m۸
'RCCG	16Grayscale Pattern	CL=8pF, V _{CC} =3.3V	41	55	ША
	Receiver Supply Current	f = 65MHz	70	04	m۸
'RCCW	Worst Case Pattern		12	94	ША
I _{RCCS}	Receiver Power Down Supply Current	/PDWN = L		10	mA

16 Gray Scale Pattern



Worst Case Pattern

CLKIN	
EVEN RxIN	
ODD RxIN	





Switching Characteristics

V_{CC} =VCC = PLL VCC = LVDS VCC

Symbol	Parameter	Min.	Тур.	Max.	Units
t _{RCP}	CLK OUT Period	15.4	Т	50.0	ns
t _{RCH}	CLK OUT High Time		4T/7		ns
t _{RCL}	CLK OUT Low Time		3T/7		ns
t _{RCD}	RCLK +/- to CLK OUT Delay		5T/7		ns
t _{RS}	TTL Data Setup to CLK OUT	0.35T-0.3			ns
t _{RH}	TTL Data Hold from CKL OUT	0.45T-1.6			ns
t _{TLH}	TTL Low to High Transition Time		2.0	3.0	ns
t _{THL}	TTL High to Low Transition Time		1.8	3.0	ns
t _{RIP1}	Input Data Position0 (T = 11.76ns)	-0.4	0.0	+0.4	ns
t _{RIP0}	Input Data Position1 (T = 11.76ns)	T/7-0.4	T/7	T/7+0.4	ns
t _{RIP6}	Input Data Position2 (T = 11.76ns)	2T/7-0.4	2T/7	2T/7+0.4	ns
t _{RIP5}	Input Data Position3 (T = 11.76ns)	3T/7-0.4	3T/7	3T/7+0.4	ns
t _{RIP4}	Input Data Position4 (T = 11.76ns)	4T/7-0.4	4T/7	4T/7+0.4	ns
t _{RIP3}	Input Data Position5 (T = 11.76ns)	5T/7-0.4	5T/7	5T/7+0.4	ns
t _{RIP2}	Input Data Position6 (T = 11.76ns)	6T/7-0.4	6T/7	6T/7+0.4	ns
t _{RPLL}	Phase Lock Loop Set			10.0	ms

AC Timing Diagrams

TTL Output







AC Timing Diagrams



Note: 1) Vdiff = (RA+) - (RA-), (RCLK+) - (RCLK-)





AC Timing Diagrams

Phase Lock Loop Set Time







Note

1)Power On Sequence Power on LVDS-Tx after THC63LVDF84B(5S).

2)Cable Connection and Disconnection

Don't connect and disconnect the LVDS cable, when the power is supplied to the system.

3)GND Connection

Connect the each GND of the PCB which LVDS-Tx and THC63LVDF84B(5S) on it. It is better for EMI reduction to place GND cable as close to LVDS cable as possible.

4)Multi Drop Connection

Multi drop connection is not recommended.



5)Asynchronous use

Asynchronous use such as following systems are not recommended.









Package

56 Lead Molded Thin Shrink Small Outline Package, JEDEC





Notices and Requests

- 1. The product specifications described in this material are subject to change without prior notice.
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